

RJK0455DPB

Silicon N Channel Power MOS FET Power Switching

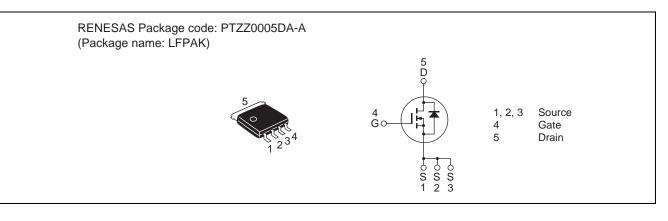
Features

- High speed switching
- Low drive current
- Low on-resistance
- $R_{DS(on)} = 3.1 \text{ m}\Omega \text{ typ.} (at V_{GS} = 10 \text{ V})$

Pb-free

- Halogen-free
- High density mounting

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

REJ03G1878-0100

Rev.1.00 Dec 04, 2009

Item	Symbol	Ratings	Unit	
Drain to source voltage	V _{DSS}	40	V	
Gate to source voltage	V _{GSS}	±20	V	
Drain current	ID	45	А	
Drain peak current	Note1	180	А	
Body-drain diode reverse drain current	I _{DR}	45	А	
Avalanche current	I _{AP} Note 2	45	А	
Avalanche energy	E _{AR} Note 2	16	mJ	
Channel dissipation	Pch Note3	60	W	
Channel to Case Thermal Resistance	θch-C	2.08	°C/W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes: 1. $PW \leq 10~\mu s,\,duty~cycle \leq 1\%$

2. Value at L=10uH, Tch = 25°C, Rg \geq 50 Ω

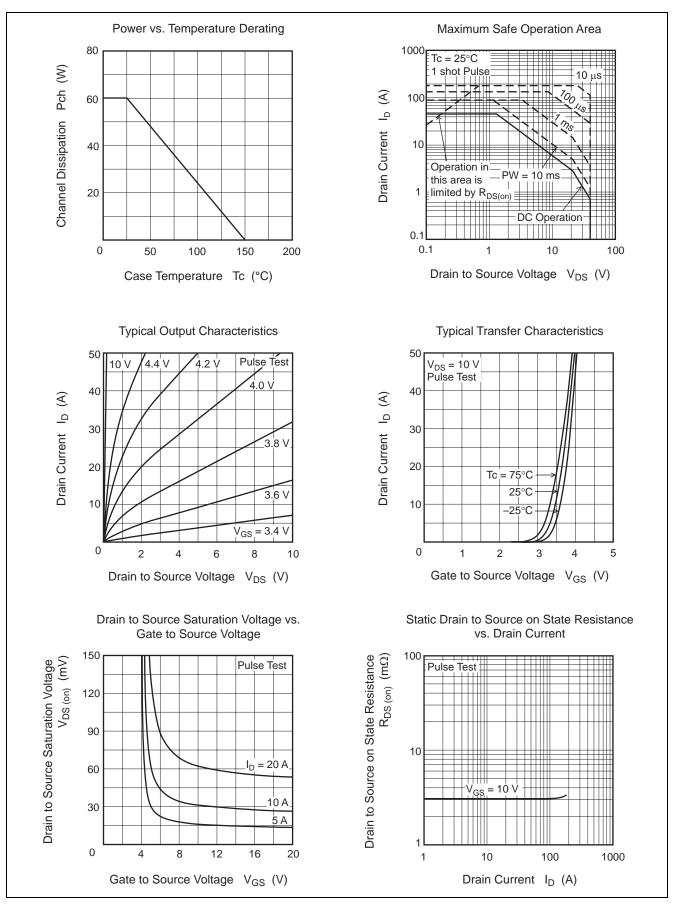
3. Tc = 25°C

Electrical Characteristics

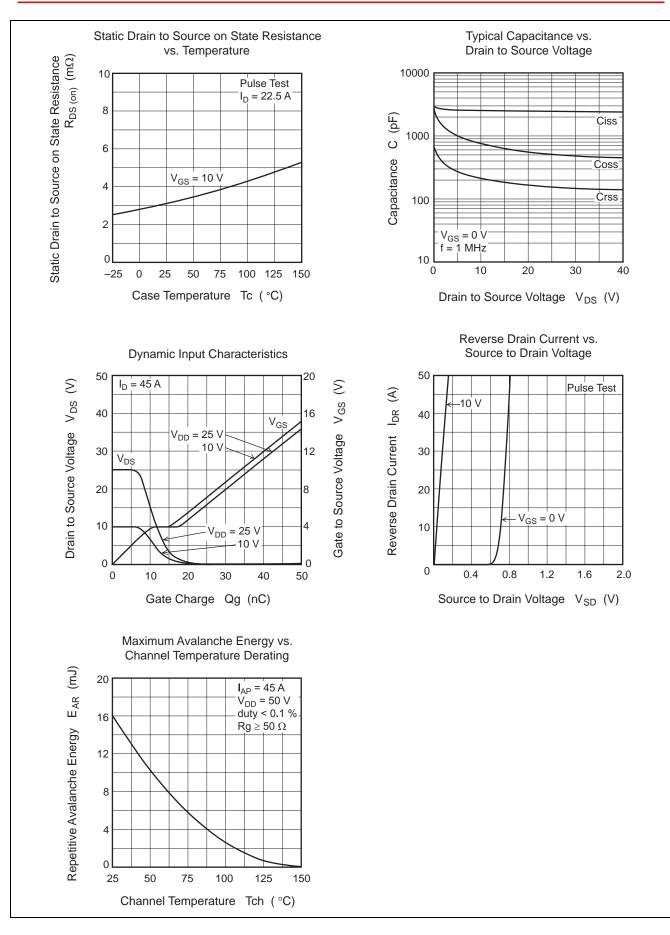
						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	40	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$
Gate to source leak current	I _{GSS}	_	—	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$
Zero gate voltage drain current	I _{DSS}	—	—	1	μΑ	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$
Gate to source cutoff voltage	V _{GS(off)}	2.0	—	4.0	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$
Static drain to source on state resistance	R _{DS(on)}	—	3.1	3.8	mΩ	$I_D = 22.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	_	52	_	S	$I_D = 22.5 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$
Input capacitance	Ciss	—	2550	_	pF	$V_{DS} = 10 V, V_{GS} = 0 V,$
Output capacitance	Coss	—	760	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	—	210	_	pF	
Gate Resistance	Rg	—	0.5	_	Ω	
Total gate charge	Qg	_	34		nC	$V_{DD} = 10 \text{ V}, V_{GS} = 10 \text{ V},$ $I_D = 45 \text{ A}$
Gate to source charge	Qgs	_	11		nC	
Gate to drain charge	Qgd	_	4.5		nC	
Turn-on delay time	t _{d(on)}	_	12		ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 22.5 \text{ A},$
Rise time	tr	_	6.0		ns	$\label{eq:VDD} \begin{split} V_{\text{DD}} &\cong 10 \text{ V}, \text{R}_{\text{L}} = 0.4 \; \Omega, \\ \text{Rg} &= 4.7 \; \Omega \end{split}$
Turn-off delay time	t _{d(off)}	_	32		ns	
Fall time	t _f	_	7.2		ns	
Body-drain diode forward voltage	V _{DF}	_	0.8	1.1	V	$I_F = 45 \text{ A}, V_{GS} = 0 \text{ V}^{Note4}$
Body-drain diode reverse recovery time	t _{rr}		39		ns	$I_F = 45 \text{ A}, V_{GS} = 0 \text{ V}$
						di _F / dt = 100 A/ μs

Notes: 4. Pulse test

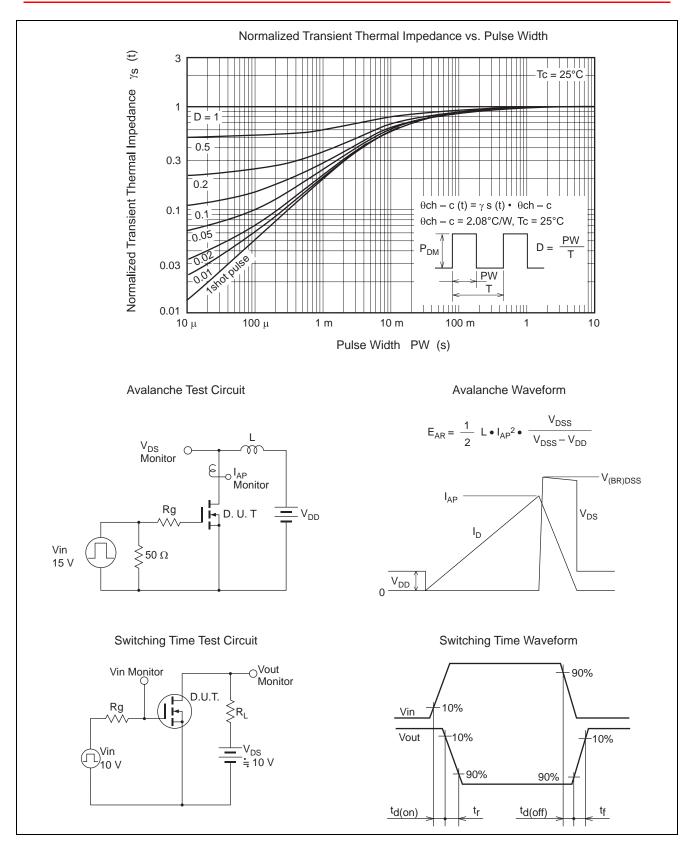
Main Characteristics



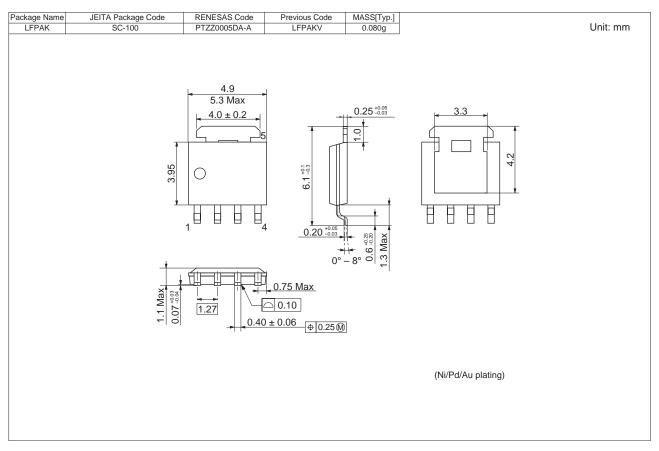
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Package Dimensions



Ordering Information

Part No.	Quantity	Shipping Container
RJK0455DPB-00-J5	2500 pcs	Taping

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